## **Special Issue**

## Feature Review Papers in Biomedical Engineering

## Message from the Guest Editor

This Special Issue aims to gather high-quality review articles highlighting recent advances, emerging technologies, and interdisciplinary developments in biomedical engineering. We welcome contributions across all areas of the Biomedical Engineering Section of *Applied Sciences*, including, but not limited to, the following: biomedical devices, biophotonics, bioinformatics of diseases, bioinstrumentation, biomedical sensors, biomedical robotics, artificial organs, health monitoring and wearable systems, biomedical signal and image processing, brain research, artificial intelligence in healthcare, and 3D bioprinting.

## **Guest Editor**

Dr. Ana María Torres Aranda

- 1. Medical Analysis Expert Group, Institute of Technology, Universidad de Castilla-La Mancha, 16071 Cuenca, Spain
- 2. Medical Analysis Expert Group, Instituto de Investigación Sanitaria de Castilla-La Mancha (IDISCAM), 45071 Toledo, Spain

## Deadline for manuscript submissions

30 June 2026



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Applied Sciences Editorial Office MDPI, Grosspeteranlage 5 4052 Basel, Switzerland Tel: +41 61 683 77 34 applsci@mdpi.com

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## Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

## **Editor-in-Chief**

Prof. Dr. Giulio Nicola Cerullo

Dipartimento di Fisica, Politecnico di Milano, Piazza L. da Vinci 32, 20133 Milano, Italy

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